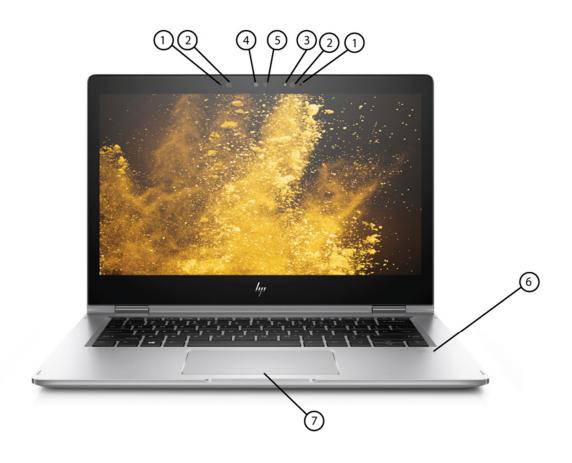
Overview

HP EliteBook x360 1030 G2



Front

- 1. Internal microphones (2)
- 2. IR emitters(2)
- 3. Webcam LED
- 4. Webcam

- 5. IR camera
- 6. Touch Fingerprint sensor
- 7. Glass Clickpad



Overview



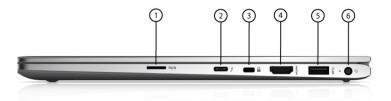
- 1. Internal microphones (2)
- 2. IR emitters(2)
- 3. Webcam
- 4. IR camera
- 5. Touch Fingerprint sensor
- 6. Glass Clickpad

Right

- 7. Smart card reader
- 8. WWAN SIM
- 9. Volume up/down
- 10. Audio combo jack
- 11. USB 3.1 Gen 1 (charging)
- 12. Power button



Overview



- 1. Micro SD slot
- 2. USB Type-C™ with Thunderbolt™
- 3. Security lock slot

Left

- 4. HDMI port
- 5. USB 3.1 Gen 1
- 6. Power connector



Conferencing Keyboard



Overview

Stand Mode







Overview

At A Glance

- Pre-installed with Windows 10 editions, FreeDOS 2.0 and NeoKylin Linux® 64
- All metal CNC Al chassis that is .59 inches (1.49 cm) thin
- Pending MIL STD 810G tests ¹
- Powered by 7th Generation Intel[®] Core[™] processors
- Choice of SSD storage drives up to 512 GB, including PCIe NVMe
- Weight starting at 2.82 lbs (1.28 kg)
- Connect without dongles using full size ports including USB, USB-C[™], and HDMI 1.4 for connecting to high-resolution displays
- Large ClickPad with gestures support
- Never forget your password with your choice of simple authentication methods, including the IR camera for face recognition and Touch Fingerprint Sensor for Windows Hello (requires Windows 10), as well as the integrated Smart Card Reader
- Optional full size HP Active Pen with App Launch, designed with Wacom technology
- HP 720p HD webcam, dual array microphones, and integrated premium stereo speakers for video audio and conferencing
- Engage teams, clients, and vendors with the crystal-clear audio by Bang & Olufsen and the high-performance HP Premium Collaboration Keyboard
 - 1. MIL STD 810G testing is pending and is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Damage under the MIL STD test conditions or any accidental damage requires an optional HP Accidental Damage Protection Care Pack.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Features

PRODUCT NAME

HP EliteBook x360 1030 G2

OPERATING SYSTEM

Preinstalled Windows 10 Pro 64¹

Windows 10 Pro 64 (National Academic only)2

Windows 10 Home 641

Windows 10 Home Single Language 641

FreeDOS 2.0 NeoKylin Linux 64

Web supported Windows 10 Enterprise 64¹

NOTE: Your product does not support Windows 8 or Windows 7

In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com

- Not all features are available in all editions or versions of Windows of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com/.
- 2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

PROCESSORS

Intel® Core™ i5-7200U with Intel HD Graphics 620 (2.5 GHz, up to 3.1 GHz with Intel Turbo Boost Technology, 3 MB cache. 2 cores)

Intel® Core™ i5-7300U with Intel HD Graphics 620 (2.6 GHz, up to 3.5 GHz with Intel Turbo Boost Technology, 3 MB cache, 2 cores)

Intel® Core™ i7-7600U with Intel HD Graphics 620 (2.9 GHz, up to 3.9 GHz with Intel Turbo Boost Technology, 4 MB cache, 2 cores)

1. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering is not a measurement of higher performance. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering is not a measurement of higher performance.



Features

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

Intel® HD1 Graphics 620 with shared video memory

1. HD content required to view HD images.

DISPLAY

Internal

33.8 cm (13.3") diagonal FHD UWVA ultra slim touch screen (1920 x 1080) with Corning® Gorilla® Glass¹ 33.8 cm (13.3") diagonal UHD UWVA ultra slim touch screen (3840 x 2160) with Corning® Gorilla® Glass¹,3

HP Sure View Integrated Privacy Screen

33.8 cm (13.3") diagonal FHD UWVA ultra slim eDP touch screen (1920 x 1080) with Corning® Gorilla® Glass^{1,4}

External

TBD

HDMI²

HDMI 1.4

- 1. HD content required to view HD images.
- 2. HDMI cable sold separately.
- 3. Planned to be available in March 2017.
- 4. Planned to be available in April 2017.

NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.

Optional Docking Solutions¹

HP Elite Thunderbolt 3 Dock HP Executive Travel Hub

1. Sold separately or as an optional feature.

STORAGE AND DRIVES

Primary Storage¹

Supports M.2 SS/DS 2280 Solid State Drive
128 GB SATA-3 Value Solid State Drive
256 GB SATA-3 Solid State Drive TLC (Opal2)
360 GB Solid State Drive PCIe NVMe (Planned to be available March 2017)
512 GB SATA-3 Solid State Drive TLC (FIPS) (Planned to be available March 2017)
256 GB PCIe Gen3x4 NVMe Solid State Drive TLC



Features

512 GB PCIe Gen3x4 NVMe Solid State Drive TLC

1. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 MB (for Windows 10) is reserved for system recovery software.

MEMORY

Standard

Memory soldered down DDR4 – 2133 (Transfer rates up to 2133 MT/s) Supports Dual Channel Memory On board (Customer non-accessible)

Configurations

4 GB (i5 only) 8 GB 16 GB (i7 only)

Maximum

16 GB DDR4-2133 SDRAM

NETWORKING/COMMUNICATIONS

Broadband Wireless (WWAN)1,2,3

HP lt4132 LTE/HSPA+ 4G Mobile Broadband HP hs3210 HSPA Mobile Broadband

Wireless LAN (WLAN) 1,2

Intel® Dual Band 802. 11a/b/g/n/ac (2x2) and Bluetooth® 4.2 Combo (non-vPro) Intel® Dual Band 802. 11a/b/g/n/ac (2x2) and Bluetooth® 4.2 Combo (vPro)

WPAN

Bluetooth® 4.2 supported via Combo card

Communications

Optional Near Field Communication (NFC)² Compatible with Miracast-certified devices⁴

- 1. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.
- 2. Sold separately or as an optional feature.
- 3. Mobile Broadband requires separately purchased service contract and factory configuration. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, and in all regions.
- 4. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information: http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast



Features

AUDIO/MULTIMEDIA

Audio

Audio by Bang & Olufsen Four integrated premium stereo speakers Dual microphone array

Camera

IR/RGB camera (standard on all models) 720p HD webcam^{1,2}

- 1. Internet access required.
- 2. HD content required to view HD images.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

Backlit

DuraKeys

Function Keys

- F1 Blank
- F2 Brightness Down
- F3 Brightness Up
- F4 Display Switch
- F5 Speaker Mute
- F6 Volume Down
- F7 Volume Up
- F8 Mic Mute
- F9 Kybd Backlight
- F10 NumLock
- F11 Wireless
- F12 Calendar
- >
- > Present/Share
- > Call Answer
- > Call End
- > Delete

ClickPad

ClickPad (Glass Cover)
Taps enabled as default
Gestures enabled by default



Features

SOFTWARE AND SECURITY

Preinstalled Software

HP BIOSphere¹

HP Sure Start Gen3¹⁰

HP DriveLock | HP Automatic DriveLock

BIOS Update via Network

Master Boot Record Security

Power On Authentication

Secure Erase²

Pre-boot Authentication

Communication

HP Mobile Connect Pro³

Native Miracast Support⁴

HP Value Add Software

HP ePrint Driver +JetAdvantage⁵

HP Hotkey Support

HP Support Assistant

HP Jumpstart

HP Noise Cancellation Software

Manageability

HP Driver Packs⁶

HP SoftPaq Download Manager (SDM)

HP System Software Manager (SSM)6

HP BIOS Config Utility (BCU)6

HP Client Catalog6

HP Manageability Integration Kit for Microsoft SCCM⁶

HP Image Assistant⁶

LANDESK Management⁷

For more information on HP Client Management Solutions refer to: http://www.hp.com/go/clientmanagement.

Microsoft Products

Buy Office

Bing Search

Skype⁸

Security

HP Client Security

- HP Security Manager (including Credential Manager and Password Manager)
- HP Drive Lock
- HP Touch Fingerprint Sensor
- HP Password Manager
- Absolute Persistence Module9
- Power On Authentication

Microsoft Defender

TPM 1.2/2.0

Security lock slot¹¹

Supports IR "Hello" facial recognition via Windows 10



Features

- 1. Available only on business PCs with HP BIOS.
- 2. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88.
- 3. HP Mobile Connect is only available on preconfigured devices with WWAN. For geographic availability refer to www.hp.com/qo/mobileconnect
- 4. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information: http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast
- 5. Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see www.hp.com/go/eprintcenter). Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary.
- 6. Not preinstalled, however available for download at http://www.hp.com/go/clientmanagement
- 7. Subscription required.
- 8. Skype is not offered in China.
- 9. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: https://www.absolute.com/en/about/legal/agreements/absolute. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.
- 10. Available on HP EliteBook products equipped with Intel® 7th generation processors
- 11. Cable not included.

POWER

Power Supply¹

HP 65W Smart AC adapter HP 65W EM Smart AC adapter HP 65W Smart USB Type-C™ AC adapter

1. Availability may vary by country.

Primary Battery

HP Long Life 3 cell, 57 Wh Li-on polymer Supports battery fast charge

NOTE: Battery is internal and not replaceable by customer.

Power Cord

TBD

Battery life1

Up to 16 hours and 30 minutes

1. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details



Features

System Standby Time TBD

WEIGHTS & DIMENSIONS

Weight1

Weight starting at 2.82 lbs (1.28 kg)

1. Weight varies by configuration and components.

Dimensions (w x d x h) 31.69 x 21.85 x 1.49 cm 12.48 x 8.6 x .59 in

PORTS/SLOTS

Ports

1 USB Type-C™ with Thunderbolt™
2 USB 3.1 Gen 1 (1 charging)
1 HDMI 1.4
1 external micro SIM
1 AC power
1 Headphone/microphone combo jack

Slots

Micro-SD Card Reader

NOTE: All cables are sold separately.

SERVICE AND SUPPORT

HP Services offers 3-year and 1-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.

- 1. Sold separately or as an optional feature.
- 2. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.



Features



Technical Specifications

DISPLAYS

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

33.8 cm (13.3") diagonal Outline Dimensions **FHD UWVA ultra slim** touch screen (1920 x 1080) with Corning® Gorilla® Glass

 $(W \times H \times D)$

300.56 x 187.57 (max.) x2.2 (max) mm

Active Area

293.76 x 165.24 mm

Weight 160g max. **Diagonal Size** 13.3" **Surface Treatment** BV **Touch enabled** Yes

Contrast Ratio 800:1 (typ - BV)

Refresh Rate 60Hz

Brightness 300 nit typ (Panel Only)

Pixel Resolution 1920 x 1080 (FHD) **Format**

> Configuration RGB

Interface eDP 1.3 w/ PSR

LCD Mode IPS/FFS/AHVA

PPI 166

Viewing Angle UWVA 85/85/85/85

33.8 cm (13.3") diagonal Outline Dimensions **UHD UWVA ultra slim** touch screen (3840 x 2160) with Corning® Gorilla® Glass

299.76 x 187.17 (max.) x 2.2(max.) mm

 $(W \times H \times D)$

Active Area 293.76 x 165.24 mm

Weight 190g max. (TBD)

Diagonal Size 13.3" **Surface Treatment** BV Touch enabled Yes

Contrast Ratio 1400:1 (typ) - BV

Refresh Rate 60Hz

Brightness 340nits typ (Panel Only)

Pixel Resolution Format 3840 x 2160 (UHD)

> Configuration **RGB**

Interface eDP 1.3 PSR **LCD** Mode IPS/FFS/AHVA

PPI 331

Viewing Angle UWVA 85/85/85/85



Technical Specifications

STORAGE AND DRIVES

128 GB SATA-3 Value Solid State Drive **Drive Weight** 0.01 lb (6 g) ~ 0.02 lb (10 g)

Capacity 128 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Performance Maximum Sequential Read Maximum Sequential Write

Up To 535 MB/s Up To 515 MB/s

Logical Blocks 250,069,680

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features DIPM; TRIM; DEVSLP

256 GB SATA-3 TLC Self- Drive Weight Encrypting Solid State Capacity Drive (Opal 2)

Drive Weight M.2 2280 **Capacity** 256 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Performance Maximum Sequential Read Maximum Sequential Write

Up to 530 MB/s Up to 515 MB/s

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; TCG Opal 2.0; DIPM; TRIM; DEVSLP

256 GB PCIe Gen3x4 NVMe TLC Solid State Drive Drive Weight M.2 2280 Capacity 256 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCIe NVMe Gen3X4

Performance Maximum Sequential Read Maximum Sequential Write

Up to 2600 MB/s Up to 900 MB/s

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security (Option); TRIM; L1.2



Technical Specifications

512 GB PCIe Gen3x4 NVMe TLC Solid State Drive **Drive Weight** M.2 2280 **Capacity** 512 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCIe NVMe Gen3X4

Performance Maximum Sequential Read Maximum Sequential Write

Logical Blocks 1,000,215,216

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security (Option); TRIM; L1.2

360 GB SATA-3 TLC Solid Drive Weight State Drive

 Drive Weight
 0.02 lb (10 g)

 Capacity
 360 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCIe NVMe Gen3X4

Performance Maximum Sequential Read Maximum Sequential Write

Logical Blocks 703,282,608

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; TRIM; L1.2

512 GB SATA-3 TLS FIPS
Solid State Drive

Drive Weight 0.02 lb (10 g) **Capacity** 512G GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 ACS-3, SATA 3.2

Performance Maximum Sequential Read Maximum Sequential Write

Up To 530 MB/s Up To 400 MB/s

Logical Blocks 1,000,215,216

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features ATA Security; TCG Opal 2.0; FIPS; DIPM; TRIM; DEVSLP



Technical Specifications

NETWORKING/COMMUNICATIONS

HP lt4132 LTE/HSPA+ 4G Mobile Broadband Module

Technology/Operating bands LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3) MHz,

850 (Band 5), 2600 (Band 7), 900 (Band 8) MHz,

800 (Band 20), 700 (Band 28) MHz.

HSPA+: 2100 (Band 1), 1900 (Band 2), 850 (Band 5), 900 (Band 8) MHz

E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 (Band 5), 900 (Band 8) MHz

Wireless protocol standards 3GPP Release 10 LTE Specification CAT.4, 20MHz BW

WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification

E-GPRS: Class B, Multi-slot class 12, coding schemes CS1 - CS4

and MSC1 - MSC9

GPS Standalone, A-GPS (MS-B and LTO)

GPS bands 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz

Maximum data rates LTE: 150 Mbps (Download), 50 Mbps (Upload)

DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload)

HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)

EDGE: 236.8 kbps (Download), 236.8 kbps (Upload)

GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)

Maximum output power LTE: 23 dBm

HSPA+: 23.5 dBm

E-GPRS 1900/1800: 26 dBm

E-GPRS 900/850: 27 dBm

GPRS 1900/1800: 29.5 dBm

GPRS 900/850: 32.5 dBm

Maximum power consumption LTE: 1,200 mA (peak); 900 mA (average)



Technical Specifications

HSPA+: 1,100 mA (peak); 800 mA (average)

E-GPRS: 2,600 mA (peak); 500 mA (average)

Form Factor M.2, 3042-S3 Key B

Weight 6 g

Dimensions 42 x 30 x 2.3 mm

(Length x Width x Thickness)

* Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

HP hs3210 HSPA+ Mobile Broadband Module*

Technology/Operating bands HSPA+: 2100 (Band 1), 1900 (Band 2), 850 (Band 5), 900 (Band 8) MHz

E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 MHz (Band 5), 900 (Band 8) MHz

Wireless protocol standards WCDMA R99, 3GPP Release 5, 6 and 7 UMTS Specification

E-GPRS: Class B, Multi-slot class 33, coding schemes CS1 - CS4 and MSC1 - MSC9

Maximum data rates HSPA+: 21.6 Mbps (Download), 5.76 Mbps (Upload)

E-GPRS: 296 kbps (Download), 236.8 kbps (Upload) GPRS: 107 kbps (Download), 85.6 kbps (Upload)

Maximum output power HSPA+: 24 dBm

E-GPRS 1800/1900: 26 dBm E-GPRS 850/900: 27 dBm GPRS 1800/1900: 30 dBm GPRS 850/900: 33 dBm

Maximum power consumption HSPA+: 1,100 mA (peak); 800 mA (average)

E-GPRS: 2,800 mA (peak); 700 mA (average)

Form Factor M.2, 2242-S3 Key B

Weight 6 g



Technical Specifications

Dimensions

1.65 x 8.66 x 0.09 in (42 x 22 x 2.38 mm)

(Length x Width x Thickness)

* Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors.

Intel® Dual Band 802. 11a/b/g/n/ac (2x2) and Bluetooth® 4.2 Combo

Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g

IEEE 802.11n

IEEE 802.11ac

Interoperability Wi-Fi certified

Frequency Band 802.11b/g/n

• 2.402 – 2.482 GHz

Note: The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

802.11a/n

- 4.9 4.95 GHz (Japan)
- 5.15 5.25 GHz
- 5.25 5.35 GHz
- 5.47 5.725 GHz
- 5.825 5.850 GHz

Note: Indonesia no support this band)

Data Rates •

• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11b: 1, 2, 5.5, 11 Mbps

- 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
- 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz,

and 80MHz)

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security¹

- IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.



Technical Specifications

WPA2 certification

IEEE 802.11i

 Cisco Certified Extensions, all versions through CCX4 and CCX Lite

WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power² • 802.11b: +16dBm minimum

802.11g:+14dBm minimum
802.11a:+14dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum
 802.11n HT40(2.4GHz): +12dBm minimum
 802.11n HT20(5GHz): +14dBm minimum
 802.11n HT40(5GHz): +12dBm minimum

Power Consumption Transmit: 2.0 W (max)

Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)

Idle mode: 50 mW (WLAN unassociated)

Connect Standby: 10 mW (WLAN+BT)

Radio disabled: 5 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 802.11b, 1Mbps: -94dBm maximum

802.11b, 11Mbps: -86dBm maximum

802.11g, 6Mbps: -88dBm maximum

802.11g, 54Mbps: -74dBm maximum

802.11a, 6Mbps: -88dBm maximum

802.11a, 54Mbps: -74dBm maximum

802.11n, MCS07: -69dBm maximum

802.11n, MCS15: -66dBm maximum

802.11ac, 1SS, MCS-0: -86dBm maximum



Technical Specifications

802.11ac, 1SS, MCS-9: -61dBm maximum

802.11ac, 2SS, MCS-0: -83dBm maximum

802.11ac, 2SS, MCS-9: -58dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card

to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230 : 2.3 x 22.0 x 30.0 mm

0r

Type 1630: 2.3 x 16.0 x 30.0 mm

Weight Type 2230 : 2.8g

0r

Type 1630: 2g

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (–10° to 70° C)

Non-operating —40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED White – Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Channels Legacy: 0~79 (1 MHz/CH)



Technical Specifications

BLE: 0~39 (2 MHz/CH)

Data Rates and Throughput Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps

BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

0.001% BER

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

0.01% BER

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device

with a maximum transmit power of + 4 dBm for BR and EDR.

Receiver Sensitivity

Power Consumption

Legacy GFSK -80 dBm -70 dBm

Modulation

π/4-DQPSK -80 dBm -70 dBm 8DPSK -80 dBm -70 dBm

L______ Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Range Legacy Up to 33 ft (10 m)

BLE Up to 99 ft (30 m)

Electrical Interface USB 2.0 compliant

Bluetooth Software Supported Microsoft Windows Bluetooth Software

Link Topology

Electrical Interface Point to Point, Multipoint Pico Nets up to 7 slaves

Bluetooth Software Supported Full support of Bluetooth Security Provisions

Security

Power Management Microsoft Windows ACPI, and USB Bus Support

Certifications Self-configurable to optimize power conservation in all operating

modes, including Standby, Hold, Park, and Sniff

Security All necessary regulatory approvals for supported countries, including:

Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249



Technical Specifications

Bluetooth Profiles Supported

Power Management ETS 300 328, ETS 300 826

Certifications Low Voltage Directive IEC950

UL, CSA, and CE Mark

Serial Port Profile (SPP)1.2

Service Discovery Application Profile (SDAP)

Dial-Up Networking (DUN)1,1

Generic Object Exchange Profile (GOEP)1,2

Object Push Profile (OPP)1,2

CertificationsHard Copy Cable Replacement (HCRP)^{1,2}
Personal Area Networking Profile (PAN)^{1,0}

Bluetooth Profiles Supported Human Interface Device Profile (HID)1.0

Hands Free Profile (HFP) 1.5/1.6

Advanced Audio Distribution Profile (A2DP) 1.3

Audio Video Remote Control Profile (AVRCP) 1.3/1.4

Bluetooth V4.1/V4.2 support V4.1: ESR5/6/7 compliant **feature**

V4.2: ESR8 compliant, LE Secure Connection – Basic.

Intel® Dual Band 802. 11a/b/g/n/ac (2x2) and Bluetooth® 4.2 Combo

Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g

IEEE 802.11n

IEEE 802.11ac

Interoperability Wi-Fi certified

Frequency Band 802.11b/g/n

2.402 – 2.482 GHz

Note: The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of



Technical Specifications

transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

802.11a/n

- 4.9 4.95 GHz (Japan)
- 5.15 5.25 GHz
- 5.25 5.35 GHz
- 5.47 5.725 GHz
- 5.825 5.850 GHz

Note: Indonesia no support this band)

Data Rates

- 802.11b: 1, 2, 5.5, 11 Mbps
- 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
- 802.11ac: MCSO ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

Modulation

Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security¹

- IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through CCX4 and CCX
 Lite
- WAPI

Network Architecture Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming

IEEE 802.11 compliant roaming between access points

Output Power²

- 802.11b: +16dBm minimum
- 802.11g: +14dBm minimum
- 802.11a: +14dBm minimum
- 802.11n HT20(2.4GHz): +14dBm minimum
- 802.11n HT40(2.4GHz): +12dBm minimum
- 802.11n HT20(5GHz): +14dBm minimum
- 802.11n HT40(5GHz): +12dBm minimum

Power Consumption

Transmit: 2.0 W (max)

Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)



Technical Specifications

Idle mode: 50 mW (WLAN unassociated)

Connect Standby: 10 mW (WLAN+BT)

Radio disabled: 5 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 802.11b, 1Mbps: -94dBm maximum

802.11b, 11Mbps: -86dBm maximum

802.11g, 6Mbps: -88dBm maximum

802.11g, 54Mbps: -74dBm maximum

802.11a, 6Mbps: -88dBm maximum

802.11a, 54Mbps: -74dBm maximum

802.11n, MCS07: -69dBm maximum

802.11n, MCS15: -66dBm maximum

802.11ac, 1SS, MCS-0: -86dBm maximum

802.11ac, 1SS, MCS-9:-61dBm maximum

802.11ac, 2SS, MCS-0: -83dBm maximum

802.11ac, 2SS, MCS-9: -58dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230 : 2.3 x 22.0 x 30.0 mm

0r

Type 1630: 2.3 x 16.0 x 30.0 mm

Weight Type 2230 : 2.8g

0r

Type 1630: 2g

Operating Voltage 3.3v +/- 9%



Technical Specifications

Temperature Operating 14° to 158° F (–10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED White – Radio ON

4. Check latest software/driver release for updates on supported security features.

5. Maximum output power may vary by country according to local regulations.

6. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Channels Legacy: 0~79 (1 MHz/CH)

BLE: 0~39 (2 MHz/CH)

Data Rates and Throughput Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps

BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

0.001% BER

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device

with a maximum transmit power of + 4 dBm for BR and EDR.

0.01% BER

Receiver Sensitivity

Legacy GFSK -80 dBm -70 dBm

Modulation

π/4-DQPSK -80 dBm -70 dBm

8DPSK -80 dBm -70 dBm

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW



Technical Specifications

Range Legacy Up to 33 ft (10 m)

BLE Up to 99 ft (30 m)

Electrical Interface USB 2.0 compliant

Bluetooth Software Supported Microsoft Windows Bluetooth Software

Link Topology

Electrical Interface Point to Point, Multipoint Pico Nets up to 7 slaves

Bluetooth Software Supported Full support of Bluetooth Security Provisions

Security

Power Management Microsoft Windows ACPI, and USB Bus Support

Certifications Self-configurable to optimize power conservation in all operating

modes, including Standby, Hold, Park, and Sniff

Security All necessary regulatory approvals for supported countries, including:

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Technical Specifications

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feature

V4.2: ESR8 compliant, LE Secure Connection – Basic.

POWER

HP 65W Smart AC adapter

Dimensions 107.0x47.0x30.0mm

Weight 250g +/- 10g

Input

Input Efficiency 88.0 % at 115 Vac and 89.0 % at 230 Vac

Input frequency range 47 ~ 63 Hz

Input AC current Max. 1.7 A at 90 Vac

Output Output power 65W

DC output 19.5V

Hold-up time 5ms at 115 Vac input

Output current limit <11.0A

Connector C6 (3pin/with grounded, with Smart ID DC connector)

Environmental Design Operating temperature 32°F to 95°F (0°to 35°C)

Non-operating (storage)

temperature -4°F to 185°F (-20°to 85°C)

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95%

Storage Humidity 10% to 95%

EMI and Safety Eg

Certifications *CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC

Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

HP 65W EM Smart AC adapter

Dimensions

127.0x51.0x30.0mm

Weight

Input

Input Efficiency 88.0 % at 115 Vac and 89.0 % at 230 Vac



350g +/- 10g

Technical Specifications

Input frequency range 47 ~ 63 Hz

Input AC current Max. 1.7 A at 90 Vac

Output Output power 65W

DC output 19.5V

Hold-up time 5ms at 115 Vac input

Output current limit <11.0A

Connector C6 (3pin/with grounded, with Smart ID DC connector)

Environmental Design Operating 8 8 1 32°F to 95°F (0°to 35°C) temperature

Non-operating (storage)

-4°F to 185°F (-20°to 85°C) temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

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* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC

Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

HP 65W Smart USB Type- Dimensions C™ AC adapter

Weight Input

74x74x28.5mm 245g +/- 10g

Input Efficiency 81.5% min at 115 Vac/ 230Vac @ 5V/3A

> 86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 10V/5A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A

Input frequency range 47 ~ 63 Hz

Input AC current 1.7 A at 90 VAC and maximum load

Output Output power 65W

> DC output 5V/9V/10V/12V/15V/20V Hold-up time 5ms at 115 Vac input

Output current limit <8.0A

Connector USB Type C **Environmental Design Operating**

> temperature 32°Fto 95°F (0°to 35°C)

Non-operating (storage)

temperature -4°Fto 185°F (-20°to 85°C) Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 5% to 95% **Storage Humidity** 5% to 95%



Technical Specifications

EMI and Safety Certifications Eg:

*CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC

Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 100,000 hours at 25°C ambient condition.

HP Long Life 3 cell, 57 Wh Li-on polymer Dimensions (H x W x L)

6.3mm x 110.05mm x 259.8mm

Weight

250g

Cells/Type

3cell Lithium-Ion

Energy

Voltage 11.55V Amp-hour capacity 4935mAh

Amp-hour capacity
Watt-hour Capacity

57Whr

Temperature

Operating (Charging)

32° to 113° F (0° to 45° C)

Operating (Discharging)

14° to 122° F(-10° to 60° C)

Non-operating

-4° to 122° F (-20° to 60° C)

Battery Re-Charge Time

System in OFF mode or

Standby

< 5 hours

System ON

Need system side power/EE confirm

Fuel Gauge LED

Optional Travel Battery

Available

No N/A

ENVIRONMENTAL

TBD

COUNTRY OF ORIGIN

China



Options and Accessories (Sold separately and availability may vary by country.)

CasesHP Business Slim Top LoadH5M91AAHP Business BackpackH5M90AADockingHP USB-C Travel DockT0K29AA#xxxHP Elite Thunderbolt 3 DockP5Q54AA#xxxHP Hot Desk StandW3Z73AAHP Hot Desk Stand Monitor ArmW3Z74AAInput/OutputHP USB-C to RJ45V7W66AA#xxxHP USB to Gigabit RJ45 AdapterN7P47AA#xxxHP USB-C to VGA AdapterN9K76AAHP USB-C to DisplayPort AdapterN9K77AAHP USB-C to DisplayPort AdapterN9K78AAHP Stereo 3.5mm HeadsetT1A66AAHP Stereo USB HeadsetT1A67AA
DockingHP USB-C Travel DockT0K29AA#xxxHP Elite Thunderbolt 3 DockP5Q54AA#xxxHP Hot Desk StandW3Z73AAHP Hot Desk Stand Monitor ArmW3Z74AAInput/OutputHP USB-C to RJ45V7W66AA#xxxHP USB to Gigabit RJ45 AdapterN7P47AA#xxxHP USB-C to VGA AdapterN9K76AAHP USB-C to HDMI AdapterN9K77AAHP USB-C to DisplayPort AdapterN9K78AAHP Stereo 3.5mm HeadsetT1A66AA
HP Elite Thunderbolt 3 Dock HP Hot Desk Stand W3Z73AA HP Hot Desk Stand Monitor Arm W3Z74AA HP USB-C to RJ45 HP USB to Gigabit RJ45 Adapter HP USB-C to VGA Adapter HP USB-C to HDMI Adapter HP USB-C to DisplayPort Adapter N9K78AA HP USB-C to DisplayPort Adapter N9K78AA HP Stereo 3.5mm Headset HP USB-C to HDMI Adapter
HP Hot Desk Stand HP Hot Desk Stand Monitor Arm W3Z74AA HP Hot Desk Stand Monitor Arm W3Z74AA Input/Output HP USB-C to RJ45 HP USB to Gigabit RJ45 Adapter HP USB-C to VGA Adapter HP USB-C to HDMI Adapter HP USB-C to DisplayPort Adapter N9K77AA HP USB-C to DisplayPort Adapter T1A66AA
HP Hot Desk Stand Monitor Arm HP USB-C to RJ45 HP USB to Gigabit RJ45 Adapter HP USB-C to VGA Adapter HP USB-C to HDMI Adapter HP USB-C to DisplayPort Adapter N9K78AA HP Stereo 3.5mm Headset HP USB-C to HDMI Adapter N9K78AA
Input/Output HP USB-C to RJ45 HP USB to Gigabit RJ45 Adapter HP USB-C to VGA Adapter HP USB-C to HDMI Adapter HP USB-C to DisplayPort Adapter N9K78AA HP Stereo 3.5mm Headset V7W66AA#xxx N7P47AA#xxx N9K76AA N9K77AA N9K78AA
HP USB to Gigabit RJ45 Adapter N7P47AA#xxx HP USB-C to VGA Adapter N9K76AA HP USB-C to HDMI Adapter N9K77AA HP USB-C to DisplayPort Adapter N9K78AA HP Stereo 3.5mm Headset T1A66AA
HP USB-C to VGA Adapter N9K76AA HP USB-C to HDMI Adapter N9K77AA HP USB-C to DisplayPort Adapter N9K78AA HP Stereo 3.5mm Headset T1A66AA
HP USB-C to HDMI Adapter N9K77AA HP USB-C to DisplayPort Adapter N9K78AA HP Stereo 3.5mm Headset T1A66AA
HP USB-C to DisplayPort Adapter N9K78AA HP Stereo 3.5mm Headset T1A66AA
HP Stereo 3.5mm Headset T1A66AA
HP Stereo USB Headset T1A67AA
HP Comfort Grip Wireless Mouse H2L63AA
HP Slim USB Keyboard and Mouse T6T83AA
HP Wireless (Link-5) Keyboard T6U20AA
HP USB Optical Travel mouse G2K28AA
Power HP 65W Smart AC Power Adapter (4.5mm) H6Y89AA#xxx
Storage HP External USB Optical Drive F2B56AA
Security HP Keyed Cable Lock 10mm T1A62AA
HP Dual Head Keyed Cable Lock T1A64AA
UCC HP Conferencing Keyboard K8P74AA#xxx
HP Speaker Phone K7V16AA
HP Wired Headset K7V17AA
Displays HP S270c 27" Curved Monitor K1M38AA#ABA
HP E230t 23" Touch Monitor W2Z50AA#ABA



Date of change	Version History	Description of change

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